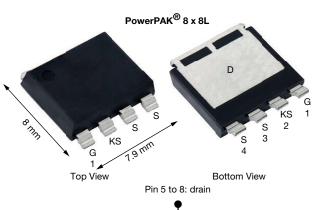
COMPLIANT

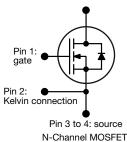
HALOGEN

**FREE** 



# **E Series Power MOSFET**





PRODUCT SUMMARY				
V <sub>DS</sub> (V) at T <sub>J</sub> max.	65	50		
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	V <sub>GS</sub> = 10 V	0.074		
Q <sub>g</sub> max. (nC)	6	3		
Q <sub>gs</sub> (nC)	1:	9		
Q <sub>gd</sub> (nC)	1	0		
Configuration	Sin	Sinale		

### **FEATURES**

- 4<sup>th</sup> generation E series technology
- Low figure of merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- · Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

### **APPLICATIONS**

- · Server and telecom power supplies
- · Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	PowerPAK 8 x 8L
Lead (Pb)-free and halogen-free	SiHM080N60E-T1-GE3

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub> = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V <sub>DS</sub>	600	V	
Gate-source voltage			$V_{GS}$	± 30	¬	
Continuous drain current (T <sub>J</sub> = 150 °C)	V <sub>GS</sub> at 10 V	$T_{\rm C} = 25  ^{\circ}{\rm C}$ $T_{\rm C} = 100  ^{\circ}{\rm C}$	- I <sub>D</sub>	51	A	
	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C		32		
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	96		
Linear derating factor				4.0	W/°C	
Single pulse avalanche energy <sup>b</sup>			E <sub>AS</sub>	173	mJ	
Maximum power dissipation			$P_{D}$	500	W	
Operating junction and storage temperature ra	nge		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-source voltage slope $T_J = 125 ^{\circ}\text{C}$		dv/dt	100	V/ns		
Reverse diode dv/dt <sup>d</sup>			10	V/115		

### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature b.  $V_{DD}$  = 120 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 3.5 A
- 1.6 mm from case
- d.  $I_{SD} \le I_D$ , di/dt = 100 A/ $\mu$ s, starting  $T_J$  = 25 °C



Vishay Siliconix

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R <sub>thJA</sub>	-	44	°C/W	
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-	0.25	C/VV	

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	600	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, I <sub>D</sub> = 1 mA		-	0.64	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		-	5.0	V
Octo commo lockero		V <sub>GS</sub> = ± 20 V		-	-	± 100	nA
Gate-source leakage	$I_{GSS}$	V <sub>GS</sub> = ± 30 V		-	-	± 1	μΑ
Zava sata valtaga dusi	1	V <sub>DS</sub> =	V <sub>DS</sub> = 600 V, V <sub>GS</sub> = 0 V		-	1	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{DS} = 480 \text{ V}$	$^{\circ}$ , $V_{GS} = 0 \text{ V}$ , $T_{J} = 125 ^{\circ}\text{C}$	-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 17 A	-	0.074	0.084	Ω
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub>	= 20 V, I <sub>D</sub> = 17 A	-	4.6	-	S
Dynamic							
Input capacitance	$C_{iss}$	$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$ f = 1  MHz		-	2557	-	
Output capacitance	C <sub>oss</sub>			-	105	-	
Reverse transfer capacitance	$C_{rss}$			-	6	-	_
Effective output capacitance, energy related <sup>a</sup>	$C_{o(er)}$	V <sub>DS</sub> = 0 V to 480 V, V <sub>GS</sub> = 0 V		-	79	-	pF
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	499	-	
Total gate charge	Qg			-	42	63	
Gate-source charge	$Q_{gs}$	$V_{GS} = 10 \text{ V}$	$V_{GS} = 10 \text{ V}$ $I_D = 17 \text{ A}, V_{DS} = 480 \text{ V}$		19	-	nC
Gate-drain charge	$Q_gd$				10	-	
Turn-on delay time	t <sub>d(on)</sub>	V <sub>DD</sub> = 480 V, I <sub>D</sub> = 17 A,		-	31	62	- ns
Rise time	t <sub>r</sub>			-	96	144	
Turn-off delay time	$t_{d(off)}$	V <sub>GS</sub> =	$V_{GS} = 10 \text{ V}, R_g = 9.1 \Omega$		37	74	
Fall time	t <sub>f</sub>			-	31	62	
Gate input resistance	$R_{g}$	f = 1 MHz		0.3	0.7	1.4	Ω
<b>Drain-Source Body Diode Characteristic</b>	cs						
Continuous source-drain diode current	Is	MOSFET symbol showing the integral reverse p - n junction diode		-	-	51	
Pulsed diode forward current	I <sub>SM</sub>			-	-	96	A
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 17 A, V <sub>GS</sub> = 0 V		-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>	$T_J = 25 ^{\circ}\text{C}, I_F = I_S = 17 \text{A},$ $di/dt = 80 \text{A/µs}, V_R = 25 \text{V}$		-	441	882	ns
Reverse recovery charge	Q <sub>rr</sub>			-	5.2	10.4	μC
Reverse recovery current	I <sub>RRM</sub>			_	21	-	A

#### Notes

- a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$
- b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

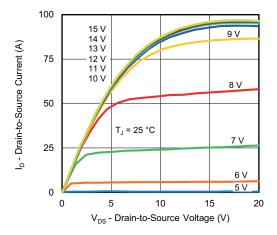


Fig. 1 - Typical Output Characteristics

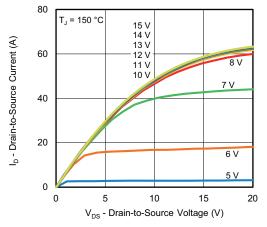


Fig. 2 - Typical Output Characteristics

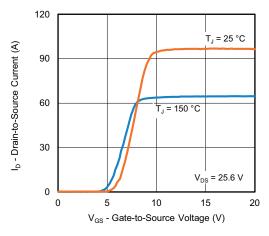


Fig. 3 - Typical Transfer Characteristics

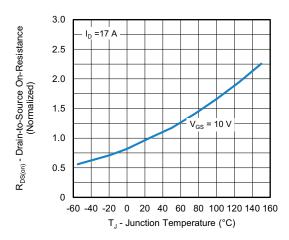


Fig. 4 - Normalized On-Resistance vs. Temperature

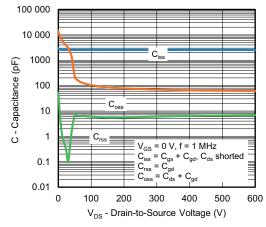


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

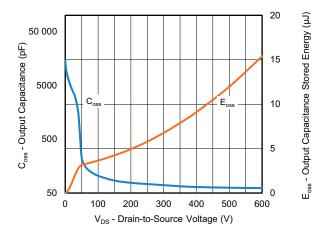


Fig. 6 - Coss and Eoss vs. VDS



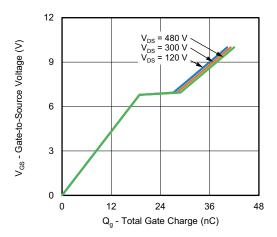


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

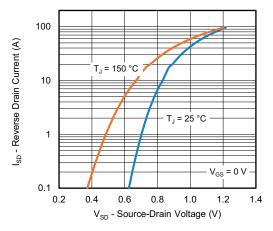


Fig. 8 - Typical Source-Drain Diode Forward Voltage

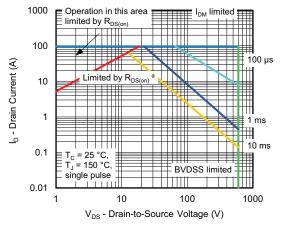


Fig. 9 - Maximum Safe Operating Area

### Note

a.  $V_{GS} > minimum \ V_{GS}$  at which  $R_{DS(on)}$  is specified

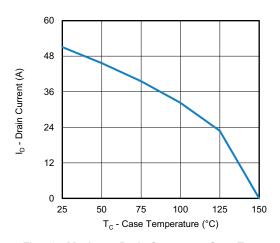


Fig. 10 - Maximum Drain Current vs. Case Temperature

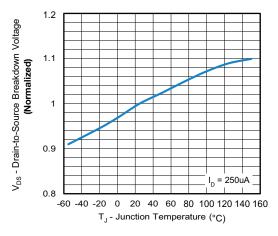


Fig. 11 - Temperature vs. Drain-to-Source Voltage



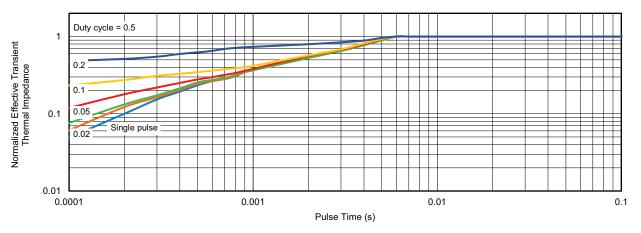


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

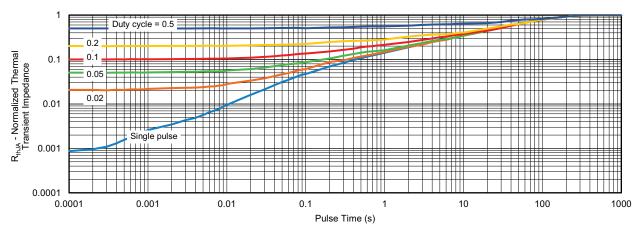


Fig. 13 - Normalized Transient Thermal Impedance, Junction-to-Ambient

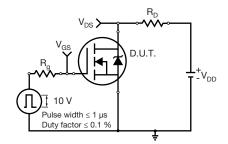


Fig. 14 - Switching Time Test Circuit

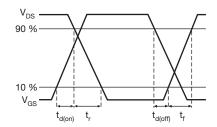


Fig. 15 - Switching Time Waveforms



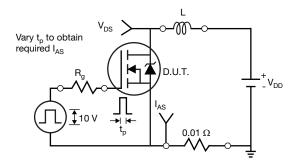


Fig. 16 - Unclamped Inductive Test Circuit

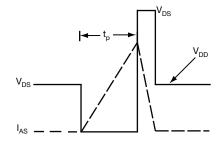


Fig. 17 - Unclamped Inductive Waveforms

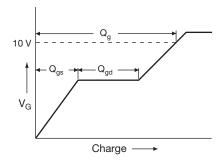


Fig. 18 - Basic Gate Charge Waveform

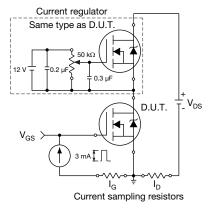
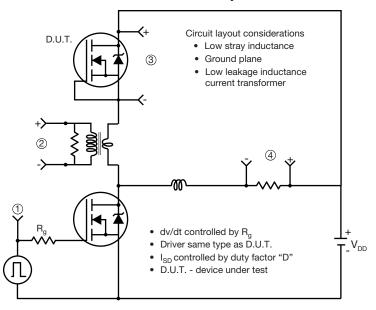


Fig. 19 - Gate Charge Test Circuit



### Peak Diode Recovery dv/dt Test Circuit



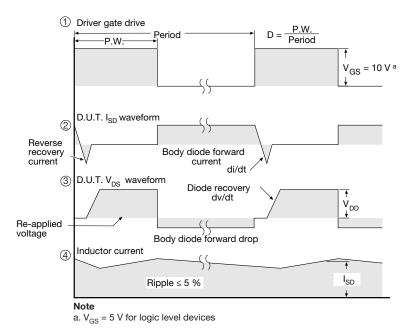


Fig. 20 - For N-Channel

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